

TMR2501

Z-axis TMR linear sensor

General Description

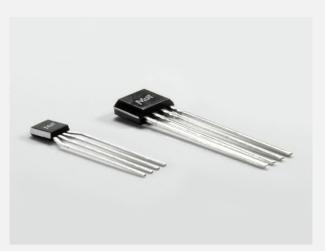
The TMR2501 linear sensor utilizes a unique push-pull Wheatstone bridge composed of four unshielded TMR sensor elements. The unique bridge design provides a high sensitivity differential output that is linearly proportional to a magnetic field applied perpendicular to the surface of the sensor package, and it provides superior temperature compensation of the output. The TMR2501 is available in the TO94 and SSIP4 packages.

Features and Benefits

- Tunneling Magneto resistance (TMR) Technology
- High Sensitivity
- Large Dynamic Range
- Low Power Consumption
- Excellent Thermal Stability
- Very Low Hysteresis
- Compatible with wide Range of Supply Voltages

Applications

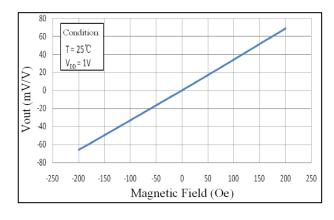
- Magnetic Field Sensing
- Current Sensors
- Position and Displacement Sensing

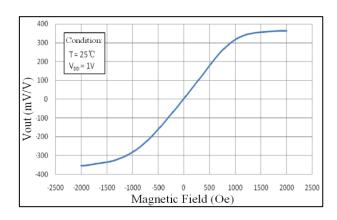


TMR2501

Transfer Curve

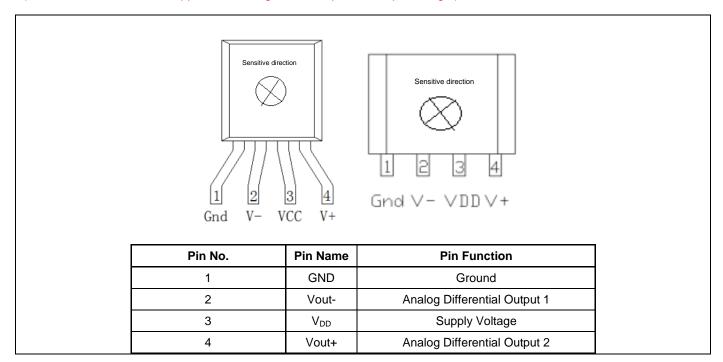
The following figure shows the response of the TMR2501 to an applied magnetic field in the range of ±200 Oe(left) and ±1000 Oe (right) when the TMR2501 is biased at 1V.





Pin Configuration

(Arrow indicates direction of applied field that generates a positive output voltage.)



Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Supply Voltage	V_{DD}	7	V
Reverse Supply Voltage	V_{RDD}	-7	V
Max Exposed Field	H _E	4000	Oe ⁽¹⁾
ESD Voltage	V_{ESD}	4000	V
Operating Temperature	T _A	-55~150	°C
Storage Temperature	T _{stg}	-70 ~165	°C

Specification (V_{CC}=1.0V, T_A=25°C, Differential Output)

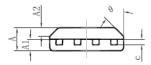
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	Vcc	Operating		1	7	V
Supply Current	Icc	Output Open			1.5 ⁽²⁾	mA
Resistance(SOP8)	R				7 ^(2,3)	KOhm
Sensitivity	SEN	Fit @ ±200 Oe	0.2		0.5	mV/V/Oe
Saturation Field	H _{sat}			±1000		Oe
Nigo Lineavity	NONII	Fit @ ±100 Oe		0.5		%FS
Non-Linearity	NONL	Fit @ ±500 Oe		1.5		%FS
Offset Voltage	V _{offset}		-10		10	mV/V
Hysteresis	Hys	Fit @±100 Oe			1	Oe
Temperature Coefficient of Resistance	TCR	H = 0 Oe		-365		PPM/°C
Temperature Coefficient of Offset	TCO	-55°C~150°C		-0.015		mV/V/°C
Temperature Coefficient of Sensitivity	TCS	-55°C~150°C		345		PPM/°C

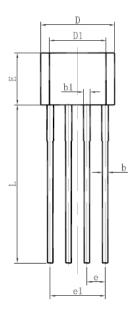
Notes:

- (1) 1 Oe (Oersted) = 1 Gauss in air = 0.1 millitesla = 79.8 A/m.
- (2) lcc= Vcc/ R. (3) Custom resistance may be available upon request.

Package Information

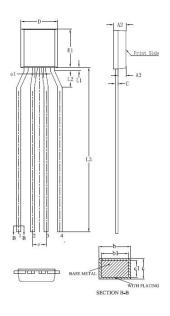
TO94 package drawing:





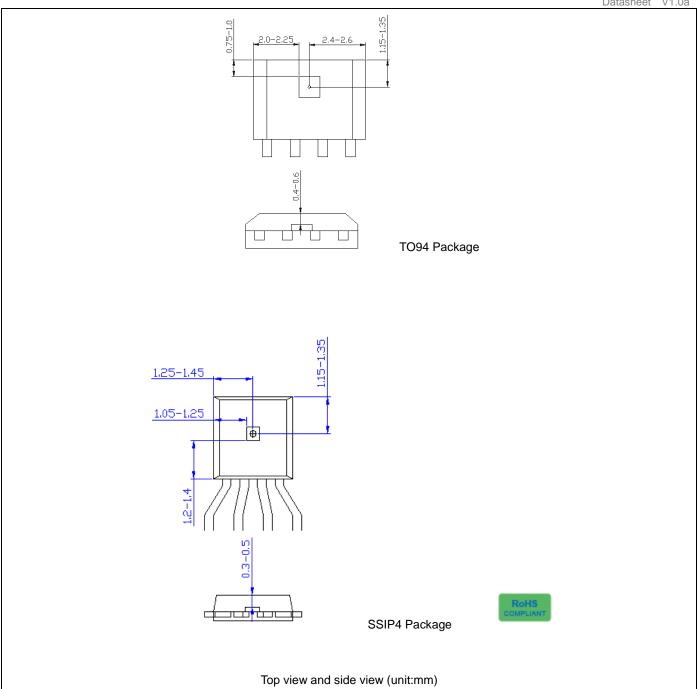
Cymah al	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.400	1.800	0.055	0.071	
A1	0.700	0.900	0.028	0.035	
A2	0.500	0.700	0.020	0.028	
b	0.360	0.500	0.014	0.020	
b1	0.380	0.550	0.015	0.022	
С	0.360	0.510	0.014	0.020	
D	4.980	5.280	0.196	0.208	
D1	3.780	4.080	0.149	0.161	
E	3.450	3.750	0.136	0.148	
е	1.270 TYP		0.050 TYP		
e1	3.710	3.910	0.146	0.154	
L	14.900	15.300	0.587	0.602	
θ	45°	TYP	45°	TYP	

SSIP4 package drawing:



SYMBOL	MILLIMETER			
SYMBOL	MIN	NOM	MAX	
A2	0.80	0.90	1.00	
A3	0.55	0.60	0.65	
Ъ	0.28	<u>-</u>	0.38	
ь1	0.27	0.30	0.33	
c	0.20	702—20	0.26	
cl	0.19	0.20	0.21	
D	2.85	2.90	2.95	
E1	2.70	2.80	2.90	
L1	0.20	0.25	0.30	
L.2	1.10	1.20	1.30	
L3	11.80	12.00	12.20	
e	1.00BSC			
e1	0.64BSC			

TMR Sensor Position









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